FDMS86101A N-Channel PowerTrench[®] MOSFET 100 V, 60 A, 8 m Ω

Features

- Max $r_{DS(on)}$ = 8 m Ω at V_{GS} = 10 V, I_D = 13 A
- Max r_{DS(on)} = 13.5 mΩ at V_{GS} = 6 V, I_D = 9.5 A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- MSL1 robust package design
- 100% UIL tested
- 100% Rg tested
- RoHS Compliant

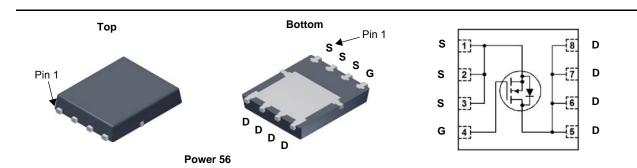


General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench[®] process thant has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Application

DC-DC Conversion



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			100	V	
V _{GS}	Gate to Source Voltage			±20	V	
Ι _D	Drain Current -Continuous (Package limited)	T _C = 25 °C		60		
	-Continuous (Silicon limited) T _C			81		
	-Continuous	T _A = 25 °C	(Note 1a)	13	Α	
	-Pulsed			180		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	486	mJ	
P _D	Power Dissipation	T _C = 25 °C		104	W	
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.2	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	50	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86101A	FDMS86101A	Power 56	13 "	12 mm	3000 units

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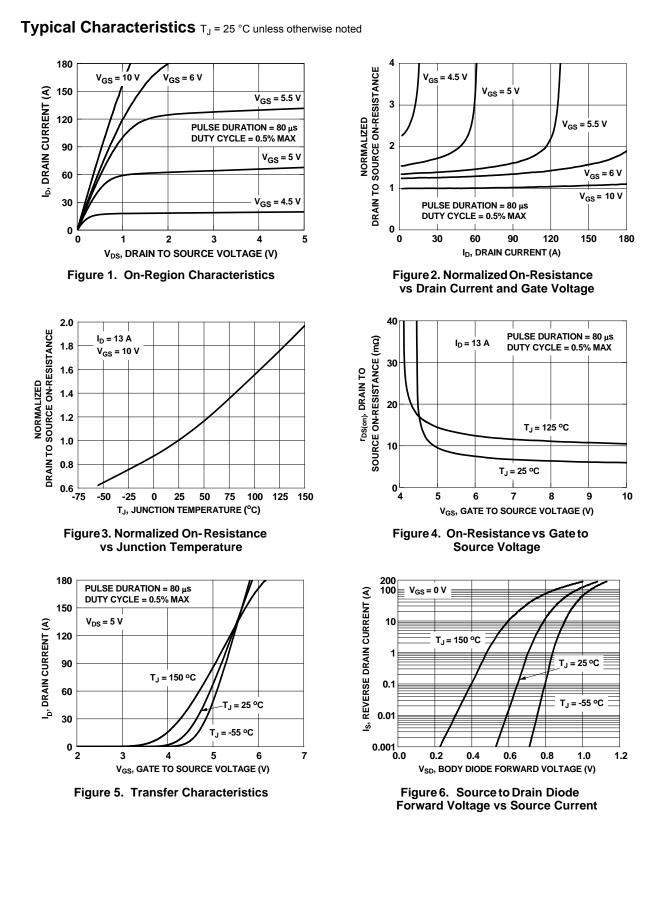
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	Parameter	Test Conditions	Min	Тур	Max	Units
JII Chara	octeristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	100			V
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		71		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 80 V, V _{GS} = 0 V			800	nA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
on Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	2.0	3.1	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{.1}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C	2.0	-9	4.0	mV/°C
		V _{GS} = 10 V, I _D = 13 A		6.3	8	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 6 V, I_D = 9.5 A$		8.0	13.5	mΩ
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		10.3	13.1	
9 _{FS}	Forward Transconductance	$V_{\rm DS} = 10 \text{ V}, \text{ I}_{\rm D} = 13 \text{ A}$		53		S
	Characteristics	50 5		<u> </u>	Į	
•	Characteristics			2005	4120	~ Г
C _{iss}		V _{DS} = 50 V, V _{GS} = 0 V,		3095	4120	pF
C _{oss}	Output Capacitance	f = 1 MHz		460	615	рF
C _{rss}	Reverse Transfer Capacitance		0.4	15	25	pF
R _g	Gate Resistance		0.1	1.6	3.3	Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			19	35	ns
t _r	Rise Time	V _{DD} = 50 V, I _D = 13 A,		5.4	11	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		27	44	ns
t _f	Fall Time			4	10	ns
Qg	Total Gate Charge	V_{GS} = 0 V to 10 V		42	58	nC
Qg	Total Gate Charge	V_{GS} = 0 V to 5 V V _{DD} = 50 V,		22	31	nC
Q _{gs}	Gate to Source Charge	I _D = 13 A		13.5		nC
Q _{gd}	Gate to Drain "Miller" Charge			6.2		nC
Drain-Sou	urce Diode Characteristics					
		V_{GS} = 0 V, I _S = 2.1 A (Note 2)		0.74	1.2	
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 13 A$ (Note 2)		0.81	1.3	V
t _{rr}	Reverse Recovery Time			64	102	ns
Q _{rr}	Reverse Recovery Charge	—I _F = 13 A, di/dt = 100 A/μs		102	164	nC

2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

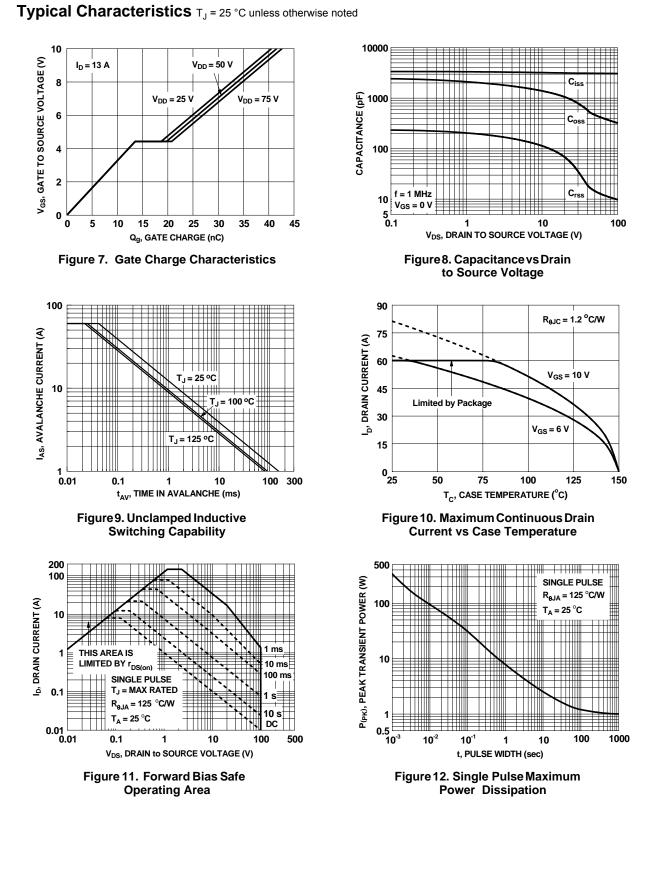
3. E_{AS} 486 mJ is based on starting T_J = 25 °C, L = 3 mH, I_{AS} = 18 A, V_{DD} = 100 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 51 A.

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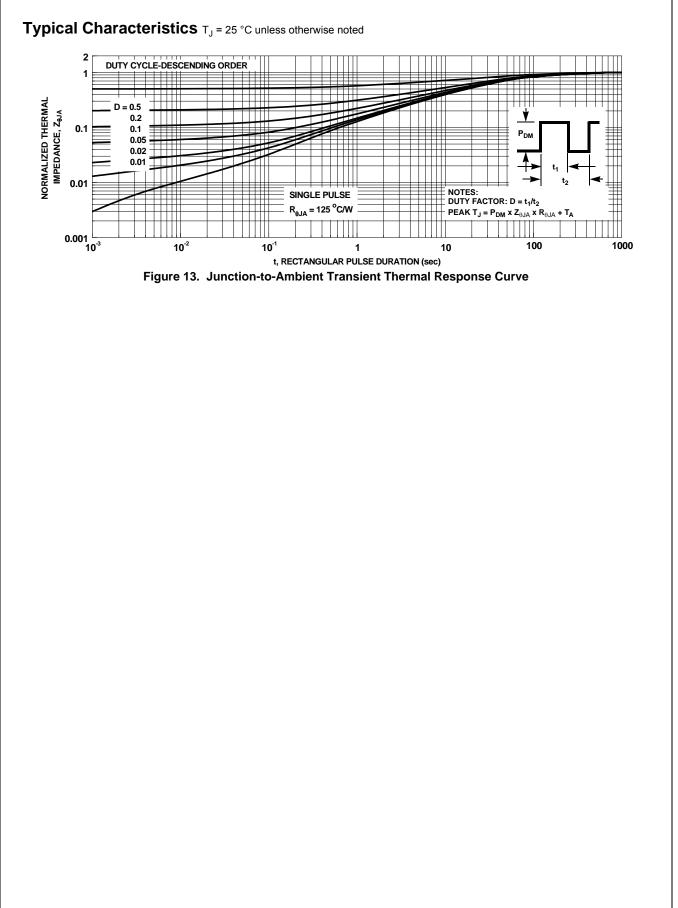




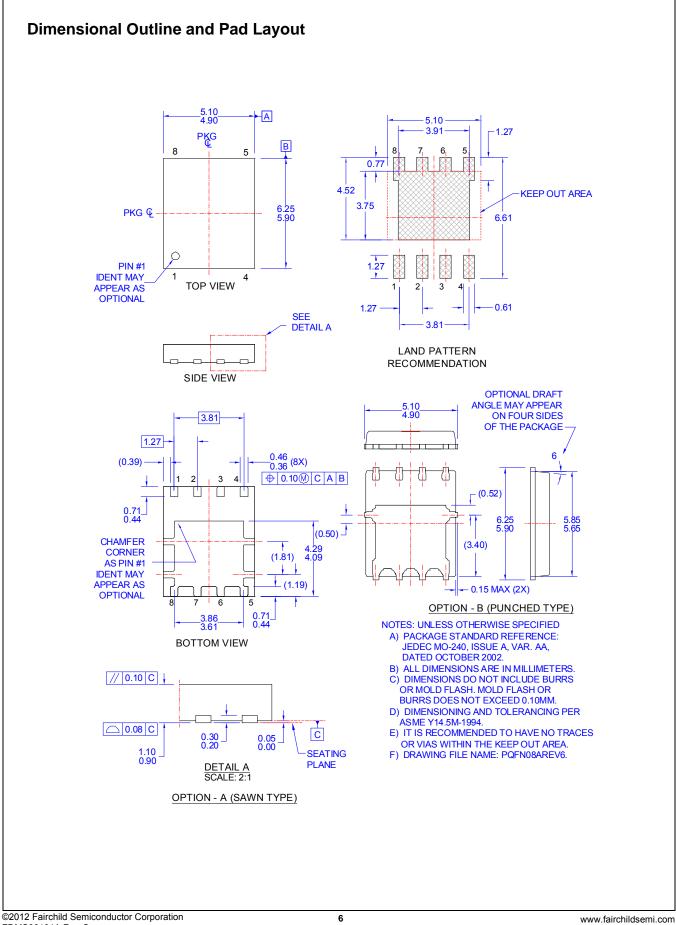
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